DMTH4007SPSWQ

40V +175°C N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

#### **Product Summary**

BV <sub>DSS</sub>	Rds(on) Max	I <sub>D</sub> Max T <sub>C</sub> = +25°C (Note 5)
40V	$7.6m\Omega @ V_{GS} = 10V$	100A

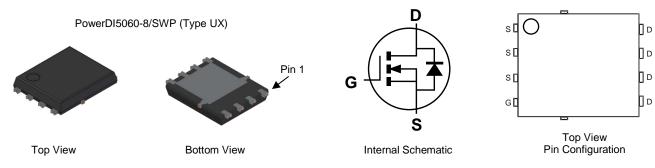
#### **Features**

- Rated to +175°C Ideal for High Ambient Temperature Environments
- Thermally Efficient Package Cooler Running Applications
- High Conversion Efficiency
- Low RDS(ON) Minimizes On-State Losses
- Low Input Capacitance
- Fast Switching Speed
- < 1.1mm Package Profile Ideal for Thin Applications
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMTH4007SPSWQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

## **Mechanical Data**

- Package: PowerDI<sup>®</sup>5060-8 •
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.097 grams (Approximate)



#### Ordering Information (Note 4)

Part Number	Packago	Packing		
	Package	Qty.	Carrier	
DMTH4007SPSWQ-13	PowerDI5060-8/SWP (Type UX)	2,500	Tape & Reel	

1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied. Notes:

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

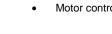
4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

5. Package limited.

# **Description and Applications**

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

- Power management
- **DC-DC** converters
- Motor controls

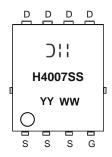








## **Marking Information**



Dill = Manufacturer's Code MarkingH4007SS = Product Type Marking CodeYYWW = Date Code MarkingYY = Last Two Digits of Year (ex: 23 = 2023)WW = Week Code (01 to 53)

## **Maximum Ratings** (@ $T_A = +25^{\circ}C$ , unless otherwise specified.)

Characteristi	Symbol	Value	Unit	
Drain-Source Voltage		Vdss	40	V
Gate-Source Voltage		Vgss	±20	V
Continuous Drain Current (Note 6)	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	ID	15.7 13.1	A
Continuous Drain Current (Note 7) $T_{C} = +25^{\circ}C \text{ (Note 5)}$ $T_{C} = +100^{\circ}C$		ID	100 77	А
Maximum Continuous Body Diode Forward Current (Note 7)		ls	100	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		Ідм	120	А
Avalanche Current, L = 0.3mH		las	20	А
Avalanche Energy, L = 0.3mH		Eas	60	mJ

#### **Thermal Characteristics**

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 6)	T <sub>A</sub> = +25°C	PD	2.8	W
Thermal Resistance, Junction to Ambient (Note 6)	Reja	53	°C/W	
Total Power Dissipation (Note 7)	Tc = +25°C	PD	136	W
Thermal Resistance, Junction to Case (Note 7)		Rejc	1.1	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +175	°C

Notes: 5. Package limited.

6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.

7. Thermal resistance from junction to soldering point (on the exposed drain pad).



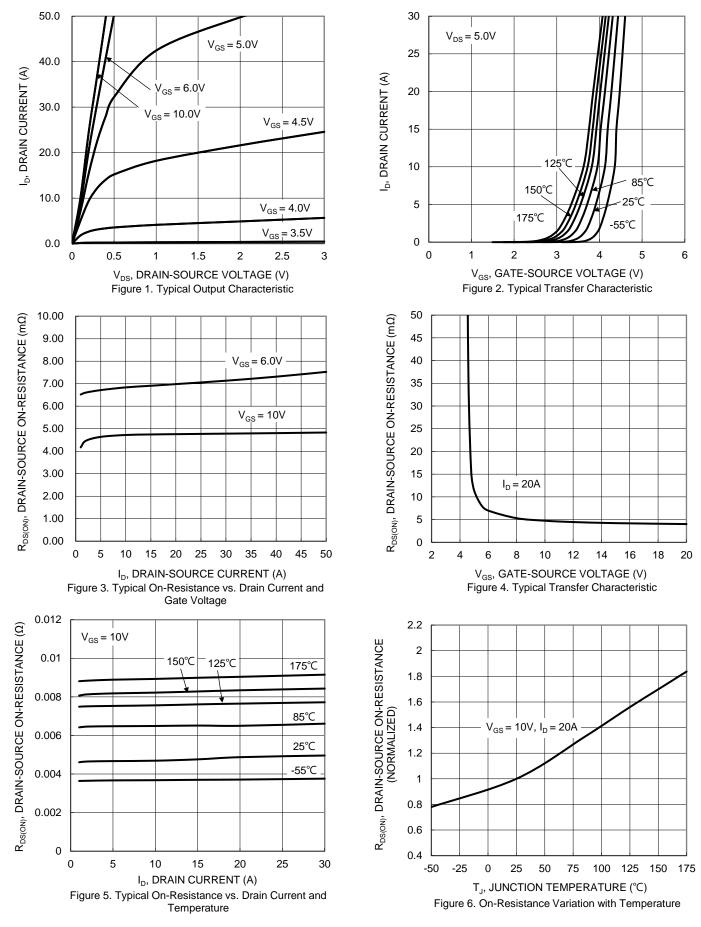
## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Min	Turp	Мах	Unit	Test Condition	
		Symbol	WIIN	Тур	wax	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)				1		.,		
Drain-Source Breakdown Voltage	r	BVDSS	40	—		V	$V_{GS} = 0V, I_D = 1mA$	
Zero Gate Voltage Drain Current		IDSS	_		1	μA	$V_{DS} = 32V, V_{GS} = 0V$	
_	(Note 9)	IDSS			100	μA	V <sub>DS</sub> = 32V, V <sub>GS</sub> = 0V, T <sub>J</sub> = +125°C	
Gate-Source Leakage		lgss	—	—	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)								
Gate Threshold Voltage		V <sub>GS(TH)</sub>	2	_	4	V	$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$	
Static Drain-Source On-Resistance		R <sub>DS(ON)</sub>	—	4.9	7.6	mΩ	$V_{GS} = 10V, I_D = 20A$	
Diode Forward Voltage		Vsd	—	_	1.2	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = 20A	
DYNAMIC CHARACTERISTICS (Note 9)								
Input Capacitance		Ciss		2,082	_			
Output Capacitance		Coss		790	_	pF	$V_{DS} = 25V, V_{GS} = 0V$ f = 1MHz	
Reverse Transfer Capacitance		Crss	_	113	_			
Gate Resistance		Rg	0.1	0.46	1.4	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Total Gate Charge Gate-Source Charge		Qg	_	41.9	_	nC	V <sub>DS</sub> = 30V, I <sub>D</sub> = 20A, V <sub>GS</sub> = 10V	
		Qgs	_	10	_			
Gate-Drain Charge		Q <sub>gd</sub>	_	11.5	_			
Turn-On Delay Time		t <sub>D(ON)</sub>	_	7	_			
Turn-On Rise Time		tR		11.5			$V_{DD} = 30V, V_{GS} = 10V$	
Turn-Off Delay Time		tD(OFF)		15.6		ns	$I_D = 20A, R_g = 3\Omega$	
Furn-Off Fall Time		tF		8.8				
Body Diode Reverse Recovery Time		t <sub>RR</sub>	_	29.9	_	ns		
Body Diode Reverse Recovery Charge		QRR	_	23	—	nC	IF = 20A, dl/dt = 100A/μs	

 Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to product testing. Notes:



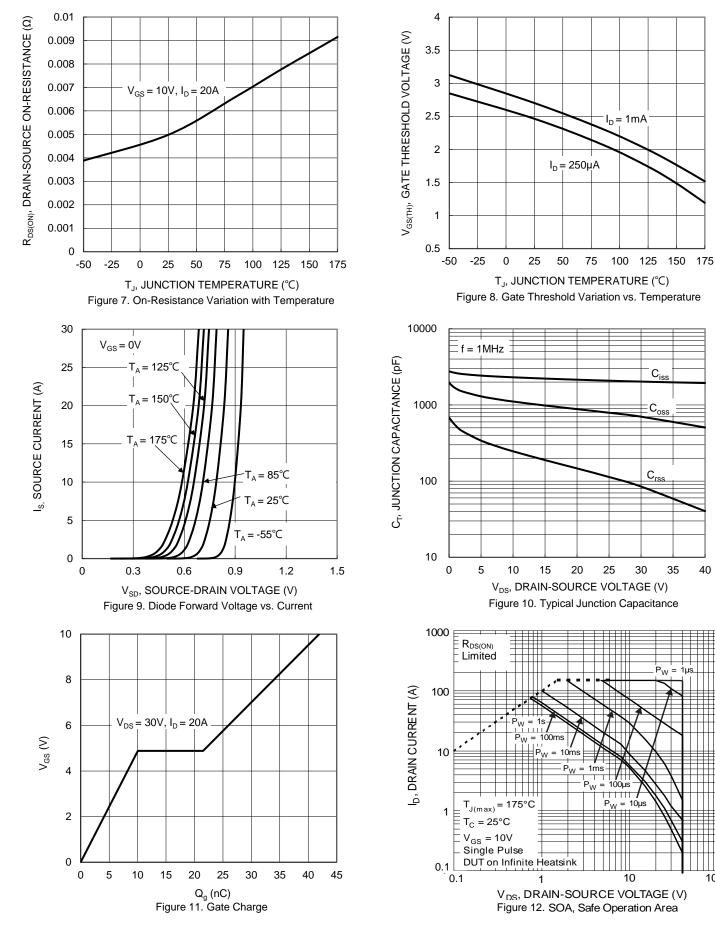
## DMTH4007SPSWQ



DMTH4007SPSWQ Document number: DS46029 Rev. 1 - 2



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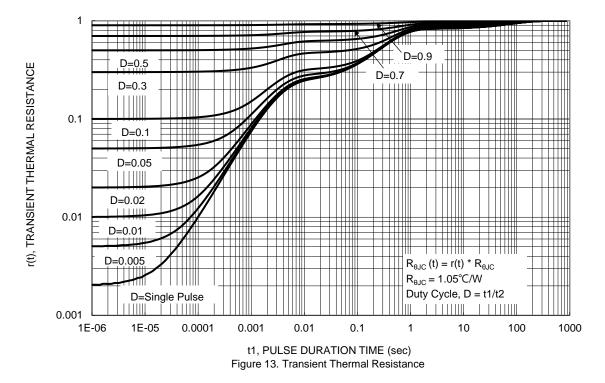
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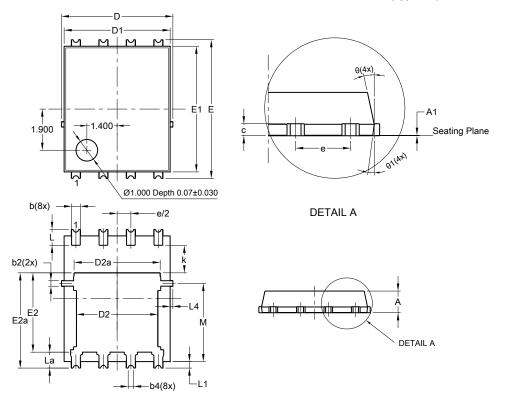


PowerDI5060-8/SWP

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## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.



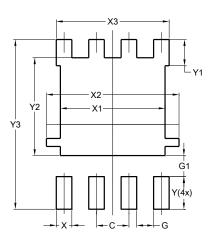
#### PowerDI5060-8/SWP (Type UX)

	(Type UX)				
Dim	Min	Max	Тур		
Α	0.90	1.10	1.00		
A1	0	0.05			
b	0.30	0.50	0.41		
b2	0.20	0.35	0.25		
b4	0	).25REF	-		
С	0.230	0.330	0.277		
D	5	.15 BS0	2		
D1	4.70	5.10	4.90		
D2	3.56	3.96	3.76		
D2a	3.78	4.18	3.98		
E	6	.40 BS0	2		
E1	5.60	6.00	5.80		
E2	3.46	3.86	3.66		
E2a	4.195	4.595	4.395		
е		.27BSC	)		
k	1.05				
L	0.635	0.835	0.735		
La	0.635	0.835	0.735		
L1	0.200	0.400	0.300		
L1a	0.050REF				
L4	0.025	0.225	0.125		
М	3.205	4.005	3.605		
θ	10°	12°	11°		
θ1	6°	8°	7°		
All	All Dimensions in mm				

### **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### PowerDI5060-8/SWP (Type UX)



Dimensions	Value		
-	(in mm)		
С	1.270		
G	0.660		
G1	0.820		
Х	0.610		
X1	4.100		
X2	5.190		
X3	4.420		
Y	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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